

November 2013

FQP10N20C / FQPF10N20C N-Channel QFET[®] MOSFET 200 V, 9.5 A, 360 mΩ

Features

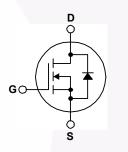
- + 9.5 A, 200 V, $R_{DS(on)}$ = 360 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 4.75 A
- Low Gate Charge (Typ. 20 nC)
- Low Crss (Typ. 40.5 pF)
- 100% Avalanche Tested

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP10N20C	FQPF10N20C	Unit	
V _{DSS}	Drain to Source Voltage		200		V	
I _D	Drain Current	-Continuous (T _C = 25 ^o C)	-Continuous ($T_c = 25^{\circ}C$) -Continuous ($T_c = 100^{\circ}C$)		9.5 *	А
	Drain Current	-Continuous (T _C = 100 ^o C)			6.0 *	А
DM	Drain Current	- Pulsed	(Note 1)	38	38 *	А
V _{GSS}	Gate to Source Voltage		± 30		V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	210		mJ
AR	Avalanche Current		(Note 1)	9.5		А
AR	Repetitive Avalanche Energy		(Note 1)	7.2		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	5.5		V/ns
P _D	Dewen Dissinction	(T _C = 25 ^o C)		72	38	W
	Power Dissipation	- Derate above 25°C		0.57	0.3	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

*Drain current limited by maximum junction temperature

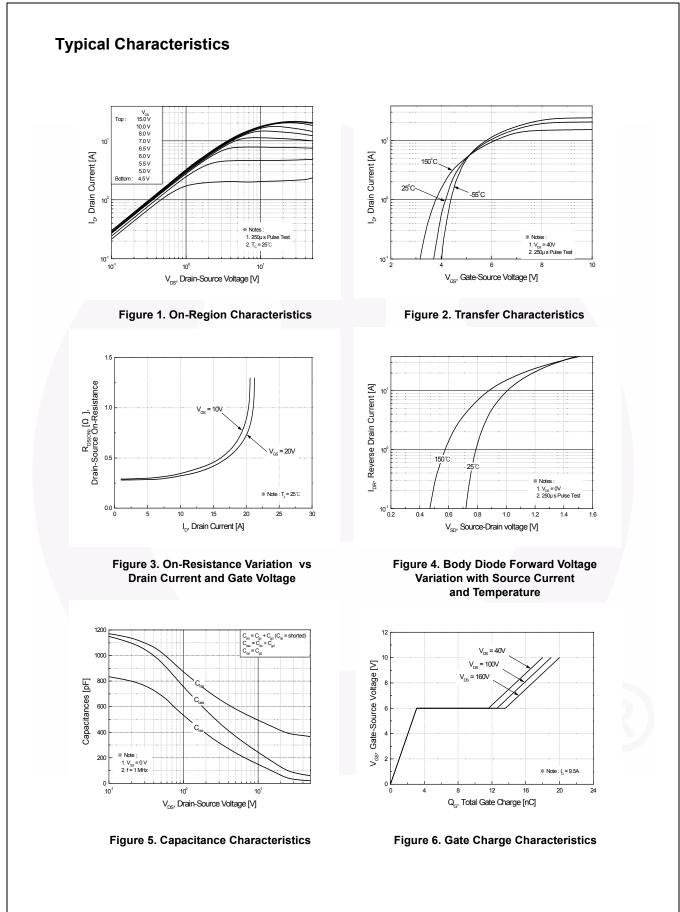
Thermal Characteristics

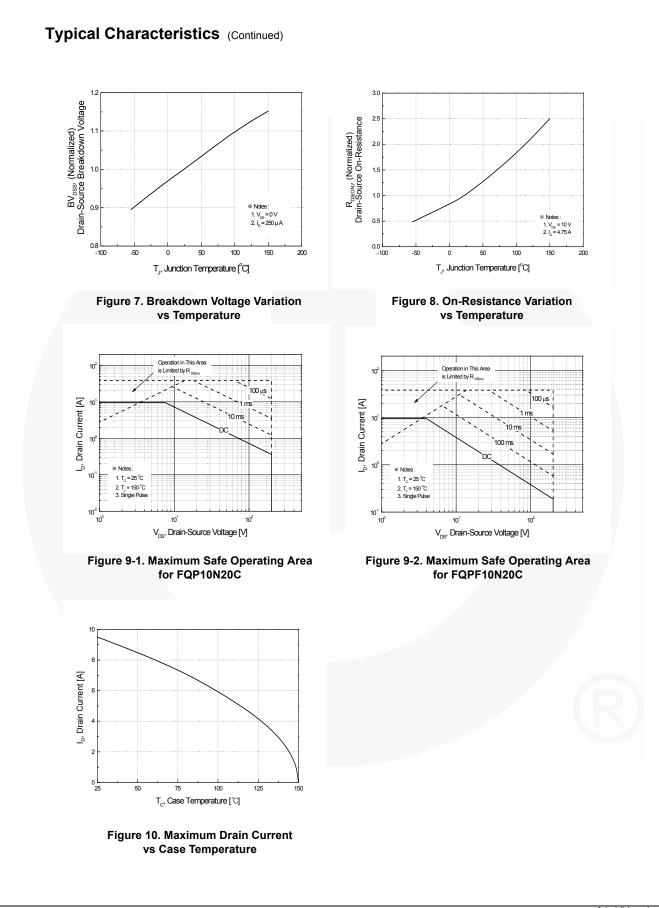
Symbol	Parameter	FQP10N20C	FQPF10N20C	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	1.74	3.33	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max	62.5	62.5	°C/W

Device Marking Device FQP10N20C FQP10N20C FQPF10N20C FQPF10N20C		Device	Package	Ree	Size	Tape Width	Qu	antity
		TO-220	Τι	ıbe	N/A	50	50 units	
		TO-220F Tu		ıbe	N/A	50 units		
lectri	cal Charact	eristics T _C = 25°C ur	nless otherwise noted.					
Symbol	F	Parameter	Test Conditions	;	Min	Тур	Max	Unit
Off Cha	aracteristics							
BV _{DSS}	1	reakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		200			V
ΔBV _{DSS} / ΔT _J		age Temperature Coeffi-	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C			0.28		V/°C
	Zana Oata Malta	Daria Oranat	V _{DS} = 200 V, V _{GS} = 0 V				10	μA
IDSS	Zero Gate Volta	ige Drain Current	V _{DS} = 160 V, T _C = 125°C		-		100	μA
I _{GSSF}	Gate-Body Leal	kage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V		-		100	nA
I _{GSSR}	Gate-Body Leal	kage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V				-100	nA
On Cha	aracteristics							
V _{GS(th)}	Gate Threshold	Voltage	V_{DS} = V_{GS} , I_D = 250 μ A		2.0		4.0	V
R _{DS(on)}	Static Drain-Sou On-Resistance	urce	V _{GS} = 10 V, I _D = 4.75 A		1	0.29	0.36	Ω
9 _{FS}	Forward Transc	conductance	V_{DS} = 40 V, I _D = 4.75 A		-	5.5		S
Dynam C _{iss} C _{oss} C _{rss}	ic Characteria Input Capacitan Output Capacita Reverse Transf	ance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			395 97 40.5	510 125 53	pF pF
						10.0	00	р.
	ing Character						~~	r
t _{d(on)}	Turn-On Delay		V _{DD} = 100 V, I _D = 9.5 A,			11	30	ns
t _r	Turn-On Rise T		R _G = 25 Ω			92	190	ns
t _{d(off)}	Turn-Off Delay		-	(Note 4)		70	150	ns
t _f	Turn-Off Fall Tir			, ,	-	72	160	ns
Q _g	Total Gate Char	-	$V_{DS} = 160 \text{ V}, \text{ I}_{D} = 9.5 \text{ A},$			20	26	nC
Q _{gs}	Gate-Source Ch		V _{GS} = 10 V (Note 4)			3.1		nC nC
Q _{gd}	Gate-Drain Cha			(1000 4)		10.5		
Drain-S	1	Characteristics and	-				9.5	A
's I _{SM}	Maximum Continuous Drain-Source Diod Maximum Pulsed Drain-Source Diode Fo						38	A
-		iode Forward Voltage	$V_{GS} = 0 V, I_S = 9.5 A$				1.5	V
Ven	Reverse Recov	0	$V_{GS} = 0 V, I_S = 9.5 A,$			158		ns
								1.5
V _{SD} t _{rr} Q _{rr}	Reverse Recov	,	dl _⊏ / dt = 100 A/µs			0.97		μC

4. Essentially independent of operating temperature.

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Typical Characteristics (Continued)

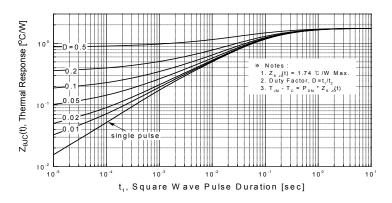
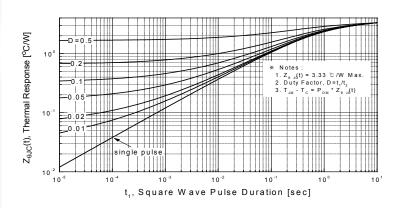
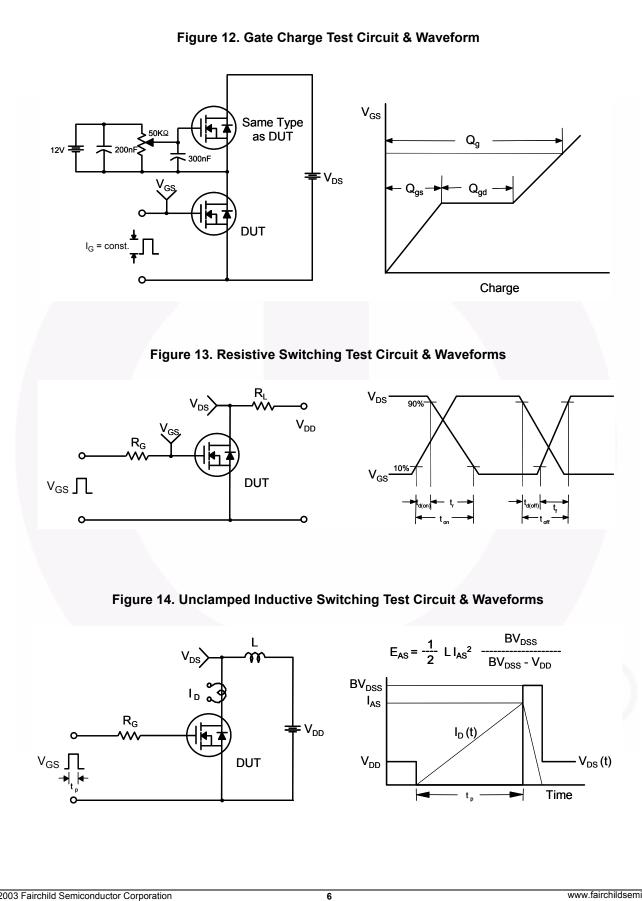
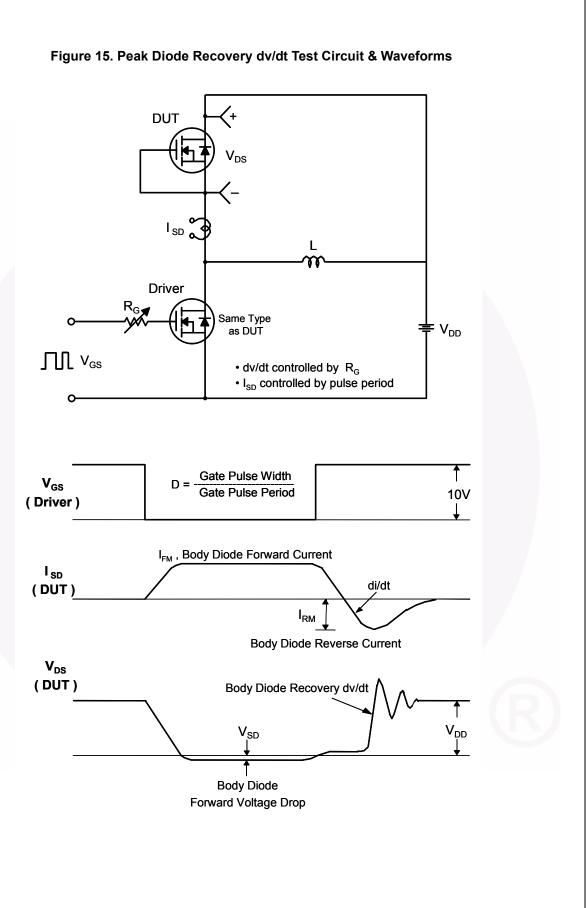


Figure 11-1. Transient Thermal Response Curve for FQP10N20C

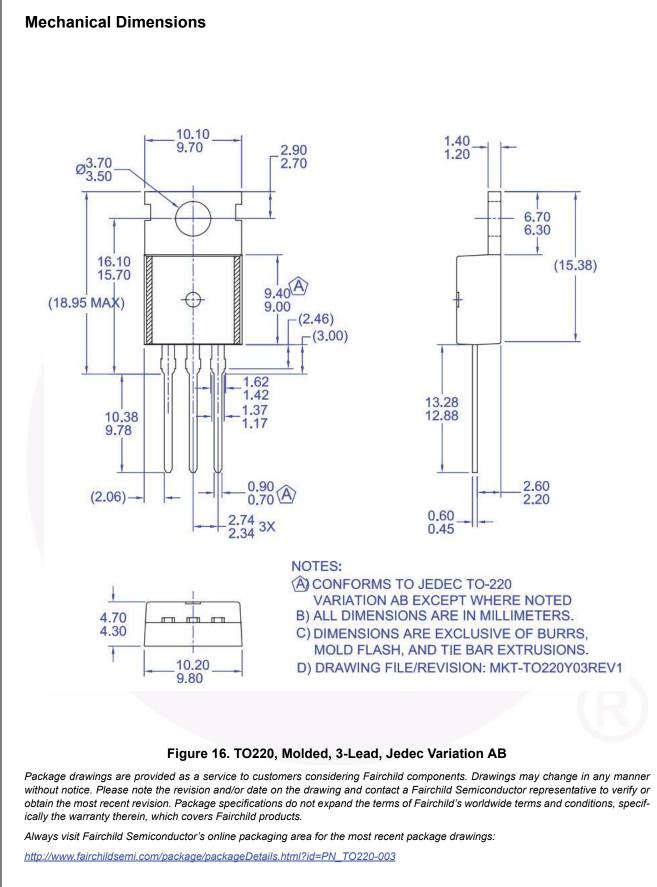


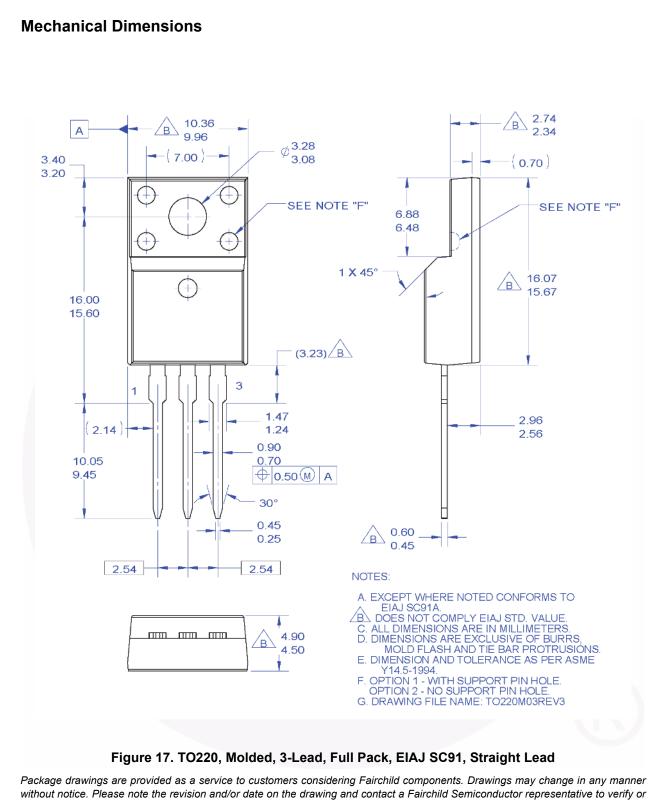






FQP10N20C / FQPF10N20C — N-Channel QFET® MOSFET





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